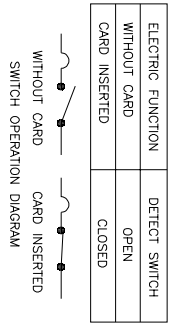
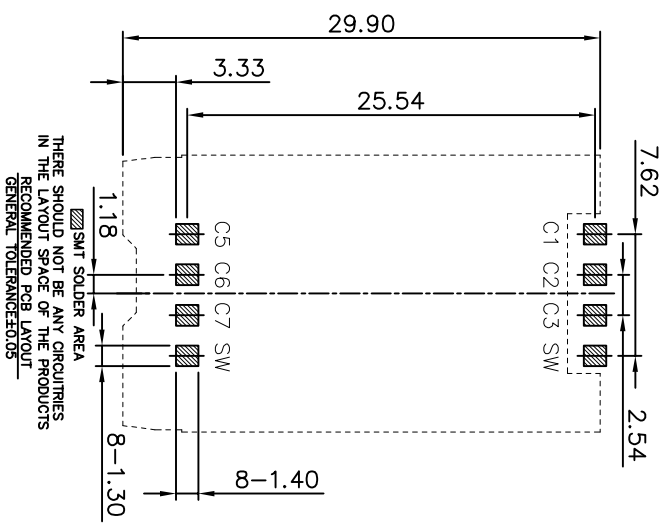


SIM CARD	
C1	Vcc
C2	RST
C3	CLK
C5	GND
SW	CD/SW
C6	Vpp
C7	DATA



- Material:
 - HOUSING: High Temperature thermoplastic; UL94V-0
 - SHELL: Stainless
 - CONTACT: Copper Alloy
- Plating of Contact
 - CONTACT: 5u" Au IN CONTACT AREA, 100u" min Sn IN SOLDER TAIL AREA, BOTH OVER 30u" min Ni UNDER PLATED OVERALL
 - SHELL: WASH OVER ALL.
- Mechanical performance
 - Mating Cycles: 5000 cycles
- Electrical performance:
 - Rating current: 1A Max.
 - Insulation resistance: 1000MΩ Min. at 500 V DC.
 - Terminal contact resistance: 100mΩ Max.
 - Withstanding voltage: 500V AC at 1mA Max. for 1 minute.
- Environment performance.
 - Operating temperature: -40°C ~ +85°C
- PRODUCT COMPLIANT TO ROHS AND HALOGEN FREE.



UNITS: mm	
GENERAL TOLERANCE	
X. ° ±5°	0. X ± 0.25
X. 1 ± 2°	0. XX ± 0.2
XX. ± 1°	0. XXX ± 0.1

CSCONN	
PART NO. (INTENDED USE)	CS108301725001
APPD:	
CHKD:	Sk11a
DR:	Kitty

CSCONN PRECISE ELECTRONICS CO., LTD	
TITLE:	SIM CARD 8P H=2.5MM 掀盖式
DWG NO.	SIM CARD
SCALE	1:1
SHEET	1 OF 2
REV	A